

JTDB 75

75 Watts, 36 Volts, Pulsed Avionics 960 - 1215 MHz

GENERAL DESCRIPTION

The JTDB 75 is a high power COMMON BASE bipolar transistor. It is designed for pulsed systems in the frequency band 960-1215 MHz. The device has gold thin-film metallization and diffused ballasting for proven highest MTTF. The transistor includes input and output prematch for broadband capability. Low thermal resistance package reduces junction temperature, extends life.

ABSOLUTE MAXIMUM RATINGS

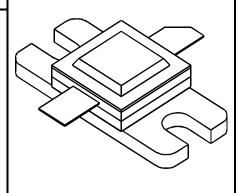
Maximum Power Dissipation @ 25°C² 220 Watts

Maximum Voltage and Current

BVcesCollector to Base Voltage55 VoltsBVeboEmitter to Base Voltage3.5 VoltsIcCollector Current8.0 Amps

Maximum Temperatures

Storage Temperature $-65 \text{ to} + 200^{\circ}\text{C}$ Operating Junction Temperature $+200^{\circ}\text{C}$ CASE OUTLINE 55AW, STYLE 1



ELECTRICAL CHARACTERISTICS @ 25 °C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Pout Pin Pg η _c VSWR	Power Out Power Input Power Gain Collector Efficiency Load Mismatch Tolerance	$F = 960-1215 \text{ MHz}$ $Vcc = 36 \text{ Volts}$ $PW = 10 \mu\text{sec}$ $DF = 40\%$ $F = 1090 \text{ MHz}$	75 7.0	7.5 40	15 3:1	Watts Watts dB %

BVebo BVces	Emitter to Base Breakdown Collector to Emitter Breakdown	Ie = 30mA $Ic = 30 mA$	3.5 55		Volts Volts
$ \frac{\mathbf{h}_{\mathrm{FE}}}{\theta \mathbf{j} \mathbf{c}^2} $	DC - Current Gain Thermal Resistance	Ic = 25 mA, Vce = 5 V	10	0.8	°C/W

Note 1: At rated output power and pulse conditions

2: At rated pulse conditions

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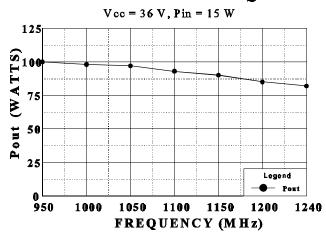
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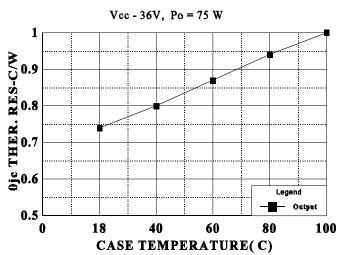


All Data shown is for operation under the rated pulse conditions.

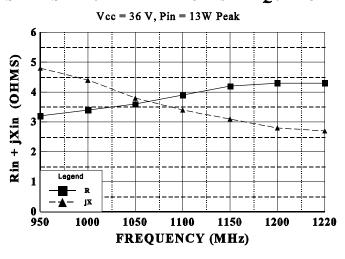
POWER OUTPUT vs FREQUENCY



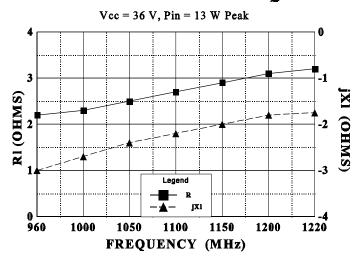
THERMAL RESISTANCE vs CASE TEMP.



SERIES INPUT IMPEDANCE vs FREQUENCY



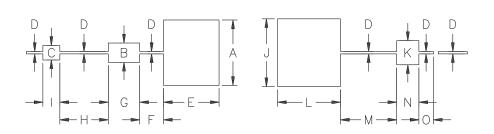
SERIES LOAD IMPEDANCE vs FREQUENCY



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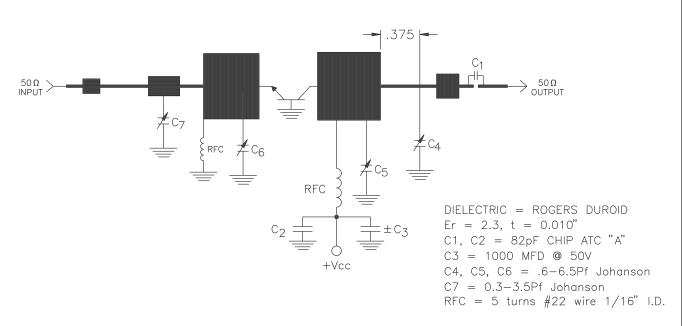
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	REVISIONS				
ZONE	REV	DESCRIPTION	DATE	APPROVED	



DIM	INCHES
А	.675
В	.200
С	.150
D	.028
E	.575
F	.245
G	.325
Н	.500
1	.175
J	.700
К	.250
L	.650
М	.580
N	.230
0	.150

JTDB 75 TEST CIRCUIT





cage 0PJR2	DWG NO.	JTDB '	75	REV $f A$	
	SCALE	1/1	SHEET		